



# Speaker Agreement

**Please complete & return form immediately!**

I agree to the SMTA Non-Commercialism Policy for presentations.

I agree to follow the SMTA Format Requirements on PPT.

I agree to submit my materials and presentation for review by the deadline.

☐ I agree to all of the above and accept the Technical Committee's invitation to present

Signature: \_\_\_\_\_

## This speaker agreement:

- 1) Confirms that you or a co-author will attend and present at the **Wafer-Level Packaging Symposium**
- 2) Verifies your current contact information for conference correspondence
- 3) Activates your record to receive the speaker discount on your conference registration.

***\*Please Note\* If you are the contact only and the speaker has not been finalized, please complete the form with your information and add TENTATIVE after your name. We will need a Speaker Agreement from the final speaker when identified.***

Use (X) to indicate your role(s): ☐ Speaker ☐ Panelist ☐ Chair ☐ Co-Chair

(X) for all that apply: ☐ Ph.D. ☐ Professor ☐ P.E. Other: \_\_\_\_\_

Name: \_\_\_\_\_

Company: \_\_\_\_\_

Position: \_\_\_\_\_

City: \_\_\_\_\_

Email: \_\_\_\_\_

State/Country: \_\_\_\_\_

Phone: \_\_\_\_\_

Zip/Country  
Code: \_\_\_\_\_

Paper Title(s) 1. \_\_\_\_\_

2. \_\_\_\_\_

**Please email completed form ASAP to [wafer@smta.org](mailto:wafer@smta.org)**